

ENGINEERING PRODUCT SPECIFICATION SPEC.NO.: SPCI042A DEPT. **PAGE: 1/3 For CI27 Connector System**

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and procedure with terminals crimped on the specified maximum size wire

2. APPLICABLE STANDARDS:

Methods for test of connectors for electronic equipment

MIL - STD - 202 MIL - STD - 1344 Test methods for electrical connectors

3. APPLICABLE SERIES NO.: CI27 Series

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 1.6 mm (.063")

6.2 P.C. Board Layout: See attached drawings

REVIEWED: Alex APPROVED: David VERIFIED: Sandy.



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7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		3A 250V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max., 100 mA max.	Less than $20 \text{ m}\Omega$
7.3	Dielectric strength	When applied AC 1000 V 1 minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than $1000~\text{M}\Omega$

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Wire size	Specified wire size	Accepts AWG#22~#28
8.2 Terminal crimp Tensile		When crimped AWG#22 size wire	More than 5.0 Kgf
	strength	When crimped AWG#24 size wire	More than 3.0 Kgf
		When crimped AWG#26 size wire	More than 2.0 Kgf
		When crimped AWG#28 size wire	More than 1.3 Kgf
8.3	Terminal insertion force	Insertion speed 25± 3 mm per minute into housing	Less than 500 gram
8.4	Contact retaining force in insulator	Retention speed 25± 3 mm per minute from housing	More than 1.5 Kgf

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Solderability	Soldering time: 5 ± 0.5 second Soldering pot: 230 ± 5°C	Minimum: 90% of immersed area
9.3	Resistance to soldering heat	Soldering time: 5 ± 0.5 second Soldering pot: 260 ± 5°C	No damage
9.4	Heat aging	85 ± 2°C , 96 hours	No damage
9.5	Humidity	40 ± 2 °C , 90-95% RH , 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Dielectric strength: To pass para 7-3



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	ITEM	TEST CONDITION	REQUIREMENT
9.6	Temperature cycling	One cycle consists of: (1)-55 - 3 °C, 30 min. (2)Room temp. 10-15 min. (3) 85 +3 °C, 30 min. (4)Room temp. 10-15 min.	Appearance: No damage
9.7	Salt spray	Temperature: 35 ± 3°C Solution: 5 ± 1% Spray time: 48 ± 4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial

10. AMBIENT TEMPERATURE RANGE: -25 to +85°C